

MAPX	MODIFICATION	DATE

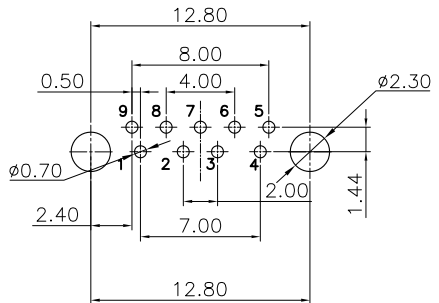
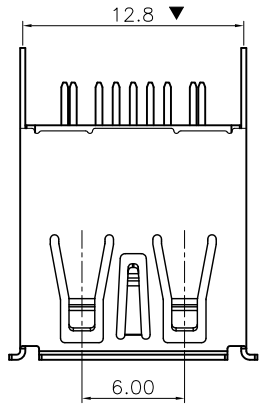
NOTES:

1.MATERIAL:

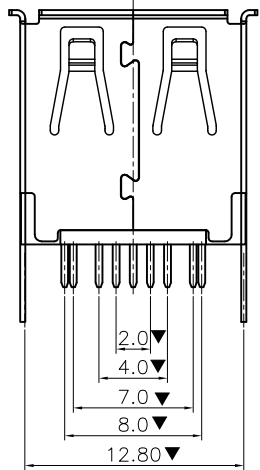
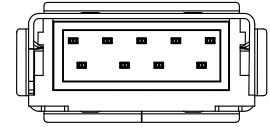
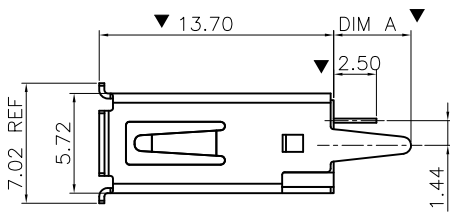
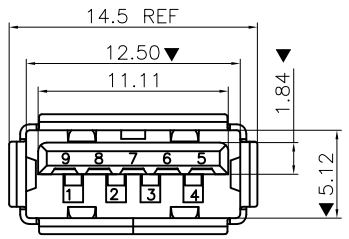
- 1.1 HOUSING: HIGH TEMPERATURE THERAL PLASTIC.
- 1.2 SPRING CONTACT: COPPER ALLOY.
- 1.3 FLAT CONTACT;COPPER ALLOY
- 1.4 SHELL :COPPER ALLOY OR IRON.
- 1.5 COVER:HIGH TEMPERATURE THERAL PLASTIC.

2.FINISH:

- 2.1 CONTACT: (SEE P/N.),[50μ"] MIN. NICKEL UNDERPLATING OVER ALL.
- 2.2 SHELL: [50μ"] MIN.SOLDERABILITY NICKEL UNDERPLATING OVER ALL.



TOLERANCE: ± 0.05 .
RECOMMENDED PCB LAYOUT



PIN NO.	PIN 1	PIN 2	PIN 3	PIN 4
SLGNAL NAME	V BUS	D-	D+	GND
REMARK	USB 2.0 CONTACT PINS			

PIN NO.	PIN 5	PIN 6	PIN 7	PIN 8	PIN 9
SLGNAL NAME	STDA_SSRX-	STDA_SSRX+	GND_DRAIN	STDA_SSTX-	STDA_SSTX+
REMARK	USB 3.0 CONTACT PINS				

产品图 PRODUCT CHART DWG		深圳市精拓金电子有限公司							
公差一览表 TOLERANCE UNLESS OTHERMSE		单位	MM	制图	尹先华	制图料号	916-252A2051Y30200		
X.	± 0.25	X.	$\pm 5^\circ$	比例	1:1	审核	郭治富	产品名称	USB AF 3.0 180度13.7直脚有边铜LCP蓝胶
.X	± 0.20	.X	$\pm 2^\circ$	日期	2021-04-14	核准	黄国荣	角法	角法
.XX	± 0.15	.XX	$\pm 1^\circ$	DATE	2021-04-14	APPD	黄国荣	版本	AD
.XXX	± 0.10	.XXX	$\pm 0.5^\circ$					VER	AD